COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

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<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: TIDA-01575</th>
<th>REV: A0</th>
<th>SUN REV: Not In VersionControl</th>
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PLOT NAME = Top Layer Assembly Drawing
GENERATED: 1/25/2018 9:05:38 AM
TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

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<th>SUN REV: Not In VersionControl</th>
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PLOT NAME = Bottom Layer Assembly Drawing
GENERATED : 1/25/2018 9:05:38 AM

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